PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: John David Williams et al.

Examiner:

Briggitte R. Hammond

Serial No.:

10/731,669

Group Art Unit:

2833

Filed:

December 8, 2003

Docket:

EPC-00007

Title:

CONNECTOR FOR MAKING ELECTRICAL CONTACT AT

SEMICONDUCTOR SCALES

SUPPLEMENTAL INFORMATION DISCLOSURE STATEMENT

Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

In compliance with the duty imposed by 37 C.F.R. § 1.56, and in accordance with 37 C.F.R. §§ 1.97 et. seq., the referenced materials are brought to the attention of the Examiner for consideration in connection with the above-identified patent application. Applicants respectfully request that this Supplemental Information Disclosure Statement be entered and the documents listed on the attached Form 1449 be considered by the Examiner and made of record. Pursuant to the provisions of MPEP 609, Applicants request that a copy of the 1449 form, initialed as being considered by the Examiner, be returned to the Applicants with the next official communication.

The Examiner is invited to contact the Applicants' Representative at the below-listed telephone number if there are any questions regarding this communication.

Pursuant to 37 C.F.R. 1.98(a)(2), Applicant believes that copies of cited U.S. Patents and Published Applications are no longer required to be provided to the Office. Notification of this change was provided in the United States Patent and Trademark Office OG Notices dated October 12, 2004. Thus, Applicant has not included copies of any US Patents or Published

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Applications cited with this submission. Should the Office require copies to be provided, Applicant respectfully requests that notice of such requirement be directed to Applicant's belowsigned representative. Applicant acknowledges the requirement to submit copies of foreign patent documents and non-patent literature in accordance with 37 C.F.R. 1.98(a)(2).

Respectfully submitted,

JOHN DAVID WILLIAMS ET AL.

By their Representatives,

CUSTOMER NUMBER: 58817

TELEPHONE NUMBER: 919-619-6630

February 15, 2007

D. Curtis Hogue Reg. No. 59,970

CERTIFICATE UNDER 37 CFR 1.8: The undersigned hereby certifies that this correspondence is being deposited with the United States Postal Servift with sufficient postage as first class mail, in an envelope addressed to: Commissioner for Patents, P.O. Box 1450, Alexandria, VA

1450, An this 15 _ day of February, 2007.

Hollingsworth

FEB 2 0 2007 Substitute for form 1449A/PTO **INFORMATION DISCLOSURE** Complete if Known STATEMENT BY APPLICANT **Application Number** 10/731,669 Filing Date December 8, 2003 **First Named Inventor** Williams, John **Art Unit** 2833 Hammond, Briggitte **Examiner Name** (Use as many sheets as necessary) Attorney Docket No: EPC-00007

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DATE CONSIDERED

PTO/SB/08a(07-05)
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Under the Paperwork Reduction Act of 1995, no persons are required to respond to a collection of information unless it contains a valid OMB control number. Substitute for form 1449A/PTO INFORMATION DISCLOSURE Complete if Known STATEMENT BY APPLICANT **Application Number** 10/731,669 Filing Date December 8, 2003 Williams, John **First Named Inventor** Art Unit 2833 Hammond, Briggitte **Examiner Name** (Use as many sheets as necessary) Attorney Docket No: EPC-00007 Sheet of

	OTHER DOCUMENTS NON PATENT LITERATURE DOCUMENTS								
Examiner Initials*	Cite No 1	Include name of the author (in CAPITAL LETTERS), title of the article (when appropriate), title of the item (book, magazine, journal, serial, symposium, catalog, etc.), date, page(s), volume-issue number(s), publisher, city and/or country where published.	T²						
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